

## Introduction

The ISL8104 is a simple single-phase PWM controller for a synchronous buck converter with integrated MOSFET driver that operates from +8V to +14.4V bias supply voltage. The ISL8104 employs voltage-mode control with dual-edge modulation to achieve fast transient response. The controller features the ability to safely start-up into prebiased output loads and provides protection against overcurrent fault events. Overcurrent protection is implemented using topside MOSFET  $r_{DS(ON)}$  sensing, eliminating the need for a current sensing resistor.

The ISL8104 evaluation board highlights the operations of the controller in a DC/DC application.

## ISL8104 Reference Design

The evaluation board is designed to optimize for the output voltage and current specifications shown in Table 1.

**TABLE 1. ISL8104 EVALUATION BOARD DESIGN PARAMETERS**

PARAMETER	MIN	TYP	MAX
Input Voltage ( $V_{IN}$ )	8V	12V	14.4V
Output Voltage ( $V_{OUT}$ )		1.8V	
Output Voltage Ripple ( $V_{RIPPLE}$ )		30mV <sub>p-p</sub>	
Continuous Load Current			20A
Switching Frequency		300kHz	

## Design Procedure

The following sections illustrate simple design steps and component selections for a converter using the ISL8104.

### Output Inductor Selection

The output inductor is chosen by the desired inductor ripple current, which is typically set to be approximately 40% of the rated output current. The desired output inductor can be calculated using Equation 1:

$$L = \frac{V_{IN} - V_{OUT}}{\Delta I} \times \frac{V_{OUT}}{V_{IN}} \times \frac{1}{F_{SW}} \quad (\text{EQ. 1})$$

$$= \frac{14.4 - 1.8}{0.4 \cdot 20} \times \frac{1.8}{14.4} \times \frac{1}{300 \times 10^3}$$

$$= 0.66\mu\text{H}$$

In the evaluation board, a 0.68μH inductor with 1.6mΩ DCR (Vishay's IHL5050FD-R68) is employed. This yields approximately 0.64W conduction loss in the inductor.

### Output Capacitor Selection

The output capacitors are generally selected by the output voltage ripple and load transient response requirements.

ESR and capacitor charge are major contributions to the output voltage ripple. Assuming that the total output capacitance is sufficient, then the output voltage ripple is dominated by the ESR, which can be calculated using Equation 2.

$$V_{RIPPLE} = \Delta I_L \cdot \text{ESR} \quad (\text{EQ. 2})$$

To meet the 30mV<sub>p-p</sub> output voltage ripple requirement, the effective ESR should be less than 4mΩ.

The output voltage response to a transient load is contributed from ESL, ESR and the amount of output capacitance. With  $V_{IN} \gg V_{OUT}$ , the amplitude of the voltage excursions can be approximated using Equation 3:

$$\Delta V = \frac{L \cdot I_{\text{tran}}^2}{C_{OUT} \cdot V_{OUT}} \quad (\text{EQ. 3})$$

With 0.68μH inductor and 0A to 20A step load, the total output capacitance of 1900μF is required for 80mV output voltage transient. In the evaluation board, four of Fujitsu's FP-4R0RE561M-L8 are employed.

### Input Capacitor Selection

The input bulk capacitors selection criteria are based on the capacitance and RMS current capability. The RMS current rating requirement for the input capacitor is approximated in Equation 4:

$$I_{IN(RMS)} = \sqrt{I_O^2(D - D^2) + \frac{\Delta I^2}{12}D} \quad D = \frac{V_O}{V_{IN}} \quad (\text{EQ. 4})$$

In this application, the RMS current for the input capacitor is 7.2A; therefore, three of Sanyo's 35ME330AX are used.

Small ceramic capacitors for high frequency decoupling are also required to control the voltage overshoot across the MOSFETs.

### MOSFET Selection

The ISL8104 requires two N-Channel power MOSFETs as the main and the synchronous switches. These should be selected based in  $r_{DS(ON)}$ , gate supply requirements and thermal management requirements.

The total power loss on MOSFET consists of conduction loss and switching loss, as shown in Equation 5:

$$P_{MOSFET(TOT)} = P_{\text{cond}} + P_{\text{sw}} \quad (\text{EQ. 5})$$

In this relatively small duty cycle design, the low-side MOSFET conducts current most of the time. To optimize the converter efficiency, select the high-side MOSFET with low gate charge for fast switching transition and low-side MOSFET with low  $r_{DS(ON)}$ .

The budget power losses in each high-side and low-side MOSFETs is 1W.

## LOW-SIDE MOSFET SELECTION

The low-side MOSFET's RMS current is approximated in Equation 6:

$$I_{L(RMS)} = I_{OUT} \cdot \sqrt{1-D} \cdot \sqrt{1 + \frac{1}{12} \cdot \left(\frac{\Delta I_L}{I_{OUT}}\right)^2} \approx 18.6A \quad (EQ. 6)$$

Assuming a target conduction loss of 0.5W in the low-side MOSFET, the ON-resistance of the low-side MOSFET must be less than 1.5mΩ. Two of Infineon's BSC030N03LS are employed in the evaluation board. The conduction loss in the low-side MOSFETs is calculated using Equation 7:

$$P_{LFET(Cond)} = I_{L(RMS)}^2 \cdot r_{DS(ON)}|_{LFET} = 0.52W \quad (EQ. 7)$$

The switching loss in the low-side MOSFETs is dominated by the loss in body diode, which can be calculated using Equation 8:

$$P_{diode} = I_O \cdot t_D \cdot V_F \cdot F_{SW} = 0.4W \quad (EQ. 8)$$

Where  $t_D$  is the total dead time in each switching period (~60ns) and  $V_F$  is the forward voltage drop of MOSFET's body diode.

The total power dissipation in the low-side MOSFETs is calculated using Equation 9:

$$P_{LFET(TOT)} = 0.92W \quad (EQ. 9)$$

## HIGH-SIDE MOSFET SELECTION

For the high-side MOSFET selection, first we assume that the conduction loss and the switching loss contribute evenly to the total power dissipation.

The high-side MOSFET's RMS current is approximated using Equation 10:

$$I_{H(RMS)} = I_{OUT} \cdot \sqrt{D} \cdot \sqrt{1 + \frac{1}{12} \cdot \left(\frac{\Delta I_L}{I_{OUT}}\right)^2} \approx 7.8A \quad (EQ. 10)$$

Hence, the required ON-resistance of the high-side MOSFET is 8.2mΩ. Infineon's BSC080N03LS is selected. The conduction loss in the high-side MOSFET is calculated using Equation 11:

$$P_{HFET(Cond)} = I_{H(RMS)}^2 \cdot r_{DS(ON)}|_{HFET} = 0.49W \quad (EQ. 11)$$

The switching loss in the high-side MOSFET can be approximated using Equation 12:

$$P_{HFET(SW)} = \frac{1}{2} \cdot I_O \cdot V_{IN} \cdot t_{tr} \cdot F_{SW} + \frac{1}{2} \cdot C_{OSS} \cdot V_{IN}^2 \cdot F_{SW} = 0.21W \quad (EQ. 12)$$

where  $t_{tr}$  is the combined ON and OFF MOSFET transition times.

The total power dissipation in high-side MOSFET is shown in Equation 13:

$$P_{HFET(TOT)} = 0.7W \quad (EQ. 13)$$

## Overcurrent Protection Setting

The OCP function is enabled with the drivers at start-up. OCP is implemented via a resistor ( $R_{TSOC}$ ) and a capacitor ( $C_{TSOC}$ ) connecting the TSOC pin and the drain of the topside MOSFET. An internal 200μA current source develops a voltage across  $R_{TSOC}$ , which is then compared with the voltage developed across the top-side MOSFET at turn on, as measured at the LX pin. When the voltage drop across the MOSFET exceeds the voltage drop across the resistor, a sourcing OCP event occurs.  $C_{TSOC}$  is placed in parallel with  $R_{TSOC}$  to smooth the voltage across  $R_{TSOC}$  in the presence of switching noise on the input bus.

A 120ns blanking period is used to reduce the current sampling error due to leading-edge switching noise. An additional simultaneous 120ns low pass filter is used to further reduce measurement error due to noise.

The OCP trip point varies mainly due to MOSFET  $r_{DS(ON)}$  variations and layout noise concerns. To avoid overcurrent tripping in the normal operating load range, find the  $R_{OCSET}$  resistor from Equation 14 with:

1. The maximum  $r_{DS(ON)}$  at the highest junction temperature
2. The minimum  $I_{TSOC}$  from the specification table in datasheet

Determine the overcurrent trip point greater than the maximum output continuous current at maximum inductor ripple current.

### Simple OCP Equation

$$R_{TSOC} = \frac{I_{OC\_SOURCE} \cdot r_{DS(ON)}}{200\mu A}$$

### Detailed OCP Equation

$$R_{TSOC} = \frac{(I_{OC\_SOURCE} + \frac{\Delta I}{2}) \cdot r_{DS(ON)}}{I_{TSOC} \cdot N_T} \quad (EQ. 14)$$

$N_T$  = NUMBER OF TOP-SIDE MOSFETs

$$\Delta I = \frac{V_{IN} - V_{OUT}}{F_{SW} \cdot L_{OUT}} \cdot \frac{V_{OUT}}{V_{IN}}$$

With Infineon's BSC080N03LS as the top-side MOSFET and  $R_{TSOC}$  of 1.15kΩ, the overcurrent trip point on the evaluation board has been approximately set to 25A.

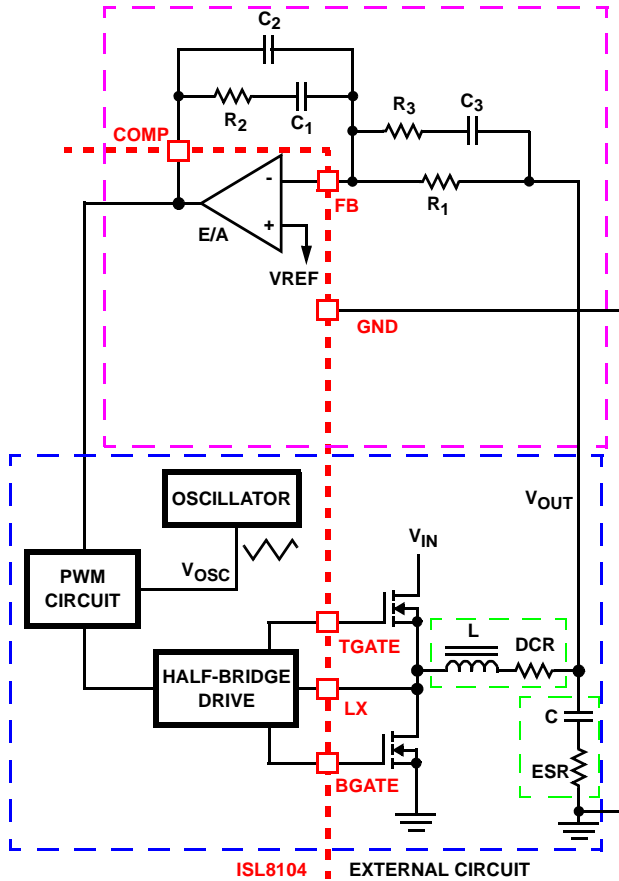


FIGURE 1. VOLTAGE-MODE BUCK CONVERTER COMPENSATION DESIGN

### Feedback Compensator

Type-III network is recommended for compensating the feedback loop. Figure 1 shows Type-III compensation configuration for the ISL8104.

With the inductor and output capacitor selected as described in the previous sections, the poles and zero of the power stage can be summarized in Equation 15:

$$F_0 = \frac{1}{2 \times \pi \times \sqrt{L \times C}} = 4.1 \text{ kHz} \quad (\text{EQ. 15})$$

$$F_{\text{ESR}} = \frac{1}{2 \times \pi \times C \times \text{ESR}} = 47.3 \text{ kHz}$$

1. With a value of 23.2kΩ for R<sub>1</sub>, select R<sub>4</sub> for the target output voltage of 1.8V using Equation 16:

$$R_4 = R_1 \times \frac{V_{\text{REF}}}{V_{\text{OUT}} - V_{\text{REF}}} \quad (\text{EQ. 16})$$

$$= 11.5 \text{ k}\Omega$$

2. With the desired feedback loop bandwidth at approximately 50kHz, R<sub>2</sub> can be calculated using Equation 17:

$$R_2 = \frac{V_{\text{OSC}} \cdot R_1 \cdot F_{\text{BW}}}{d_{\text{max}} \cdot V_{\text{IN}} \cdot F_0} \quad (\text{EQ. 17})$$

$$= 44.2 \text{ k}\Omega$$

3. Select C<sub>1</sub> such that F<sub>Z1</sub> is located at 1.5kHz:

$$C_1 = \frac{1}{2 \pi \cdot R_2 \cdot 1.5 \times 10^3} \quad (\text{EQ. 18})$$

$$\approx 2.2 \text{ nF}$$

4. Select C<sub>2</sub> such that F<sub>P1</sub> is located at F<sub>ESR</sub>:

$$C_2 = \frac{C_1}{2 \pi \cdot R_2 \cdot C_1 \cdot F_{\text{ESR}} - 1} \quad (\text{EQ. 19})$$

$$\approx 82 \text{ pF}$$

5. Select R<sub>3</sub> such that F<sub>Z2</sub> is located at F<sub>LC</sub> and F<sub>P2</sub> is located at 150kHz:

$$R_3 = \frac{R_1}{\frac{150 \times 10^3}{F_0} - 1} \approx 655 \Omega \quad (\text{EQ. 20})$$

$$C_3 = \frac{1}{2 \pi \cdot R_3 \cdot 150 \times 10^3} \approx 1.5 \text{ nF}$$

A more detailed explanation of designing compensation networks for buck converters with voltage mode control can be found in TB417 entitled "Designing Stable Compensation Networks for Single Phase Voltage Mode Buck Regulators".

### Evaluation Board Performance

Figures 2 and 3 show photographs of the ISL8104EVAL1Z and ISL8104EVAL2Z boards, respectively.

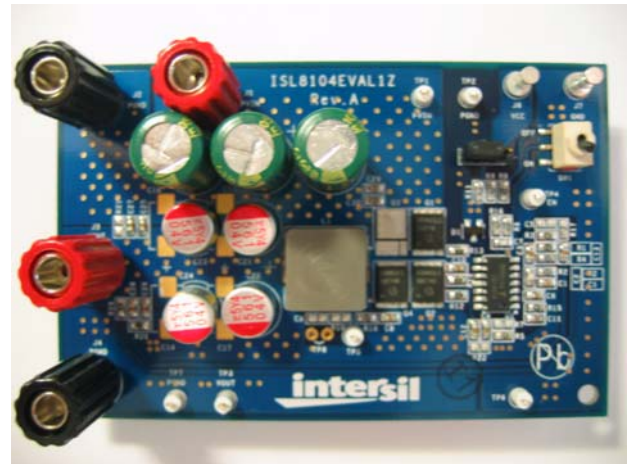


FIGURE 2. ISL8104EVAL1Z



FIGURE 3. ISL8104EVAL2Z

### Power and Load Connections

Terminals J1 and J2 are connected to the input of the power stage. For single rail supply, the IC bias supply can be tied to the converter input supply through pin 1 and 2 of the Jumper J5. When using separate supplies, provide the IC bias voltage to terminal J6 with pin 2 and pin 3 of J5 connected together. The load can be connected to terminal J4 and J5. TP6 and TP3 can be used for DMM to measure output voltage. The toggle switch, SW1, can be used to disable the controller.

### Start-up

When the voltages at  $V_{CC}$  and  $P_{VCC}$  of ISL8104 exceed their rising POR thresholds, a 30 $\mu$ A current source driving the SS pin is enabled. Upon the SS pin exceeding 1V, the ISL8104 begins ramping the non-inverting input of the error amplifier from GND to the System Reference. During initialization, the MOSFET drivers pull TGATE to LX and BGATE to PGND.

If the ISL8104 is utilizing the internal reference, then as the SS pin's voltage ramps from 1V to 3V, the soft-start function scales the reference input (positive terminal of error amp) from GND to VREF (0.597V nominal). Figure 4 shows the start-up profile of the ISL8104 in relation to the start-up of the 12V input supply and the bias supply.

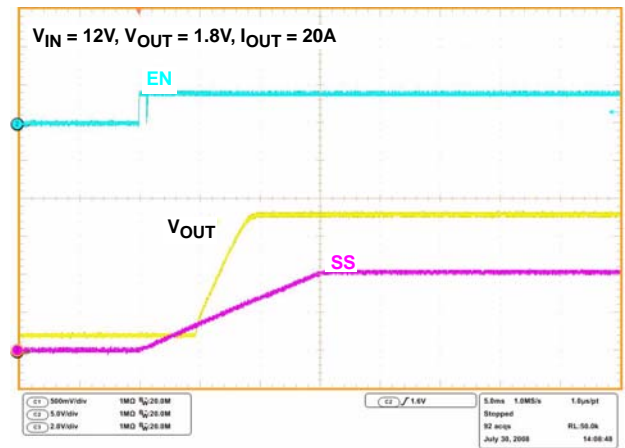


FIGURE 4. SOFT-START

### Soft-Start with Pre-Biased Output

If the output is pre-biased to a voltage less than the expected value, the ISL8104 will detect that condition. Drivers are held in tri-state (TGATE pulled to LX, BGATE pulled to PGND) at the beginning of a soft-start cycle until two PWM pulses are detected. The bottom-side MOSFET is turned on first to provide for charging of the bootstrap capacitor. This method of driver activation provides support for start-up into prebiased loads by not activating the drivers until the control loop has entered its linear region, thereby substantially reducing output transients that would otherwise occur had the drivers been activated at the beginning of the soft-start cycle.

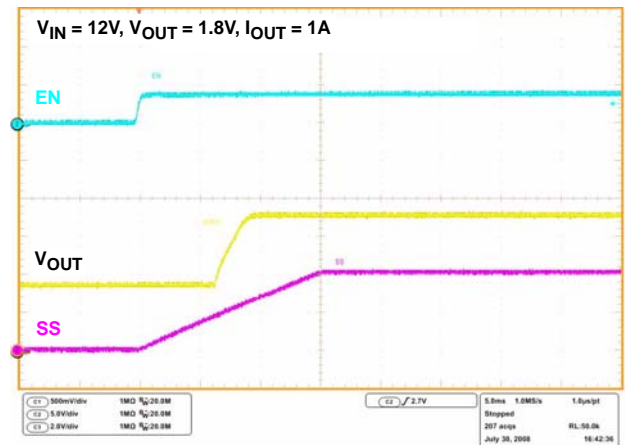


FIGURE 5. SOFT-START WITH PRE-BIASED OUTPUT



## Output Ripple

Figure 6 shows the ripple voltage on the output of the regulator.

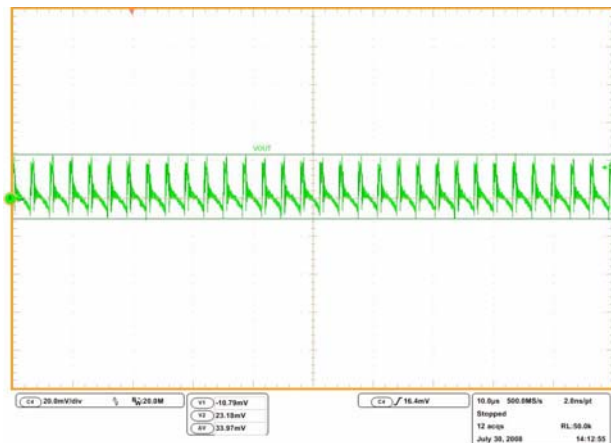


FIGURE 6. OUTPUT RIPPLE (20MHz BW)

## Transient Performance

Figures 7, 8 and 9 show the response of the output voltage when subjected to transient loading from 0A to 15A at 1A/µs.

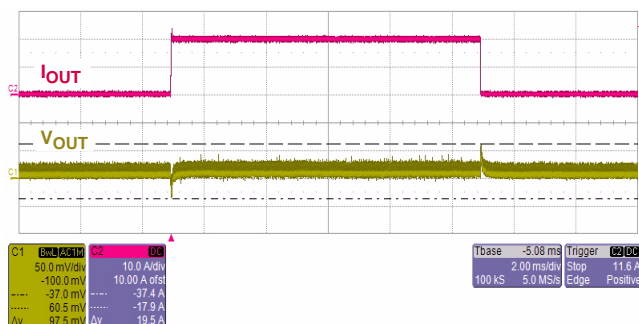


FIGURE 7. TRANSIENT RESPONSE

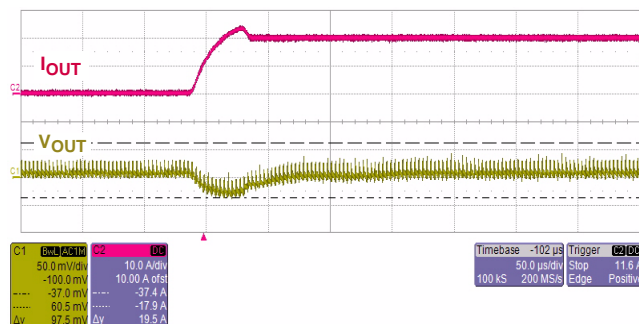


FIGURE 8. TRANSIENT RESPONSE

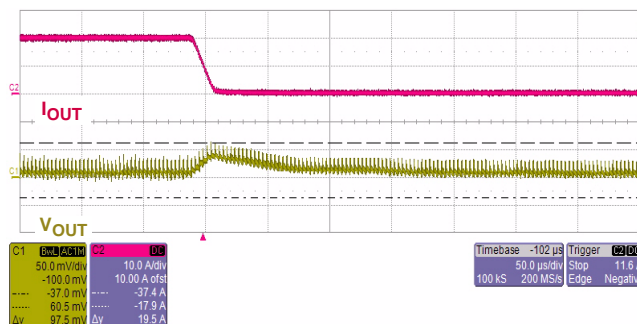


FIGURE 9. TRANSIENT RESPONSE

## Efficiency

ISL8104 based regulators enable the design of highly efficient systems. The efficiency of the evaluation board using a 12V input supply is shown in Figure 10.

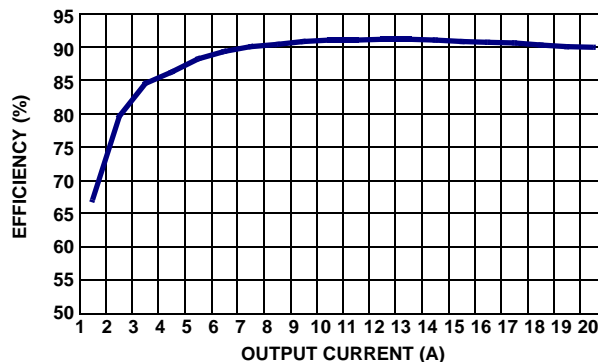


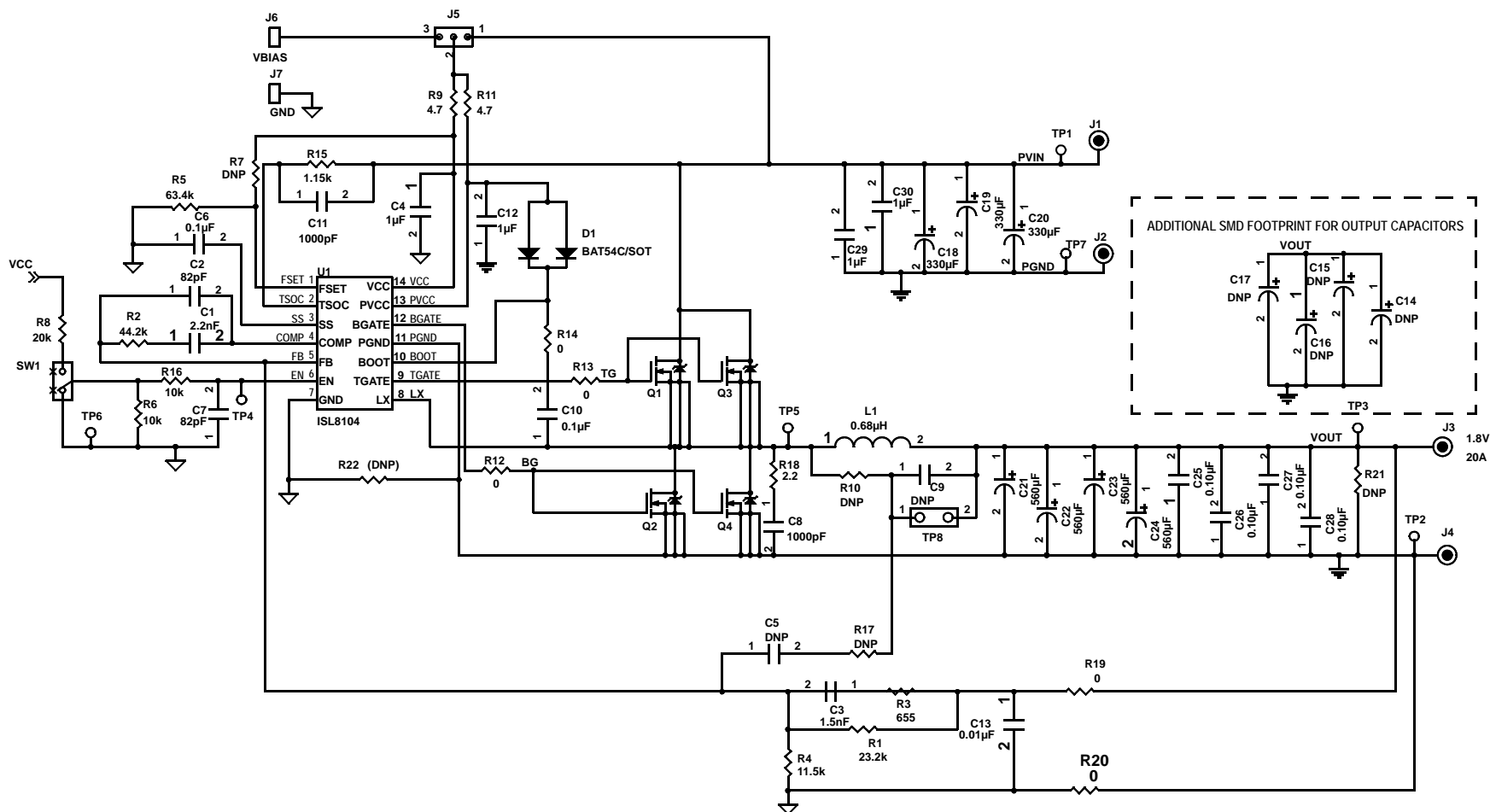
FIGURE 10. EVALUATION BOARD EFFICIENCY ( $V_{OUT} = 1.8V$ )

## References

For Intersil documents available on the web, go to <http://www.intersil.com/>.

1. ISL8104 Data Sheet "8V to 14V, Single-Phase Synchronous Buck Pulse-Width Modulation (PWM) Controller With Integrated Gate Drivers", Intersil Corporation
2. Tech Brief TB417, "Designing Stable Compensation Networks for Single Phase Voltage Mode Buck Regulators", Intersil Corporation

# ISL8104EVAL1Z Schematic



**ISL8104EVAL1Z Bill of Materials**

ID	REFERENCE	QTY	PART NUMBER	PART TYPE	DESCRIPTION	PACKAGE	VENDOR
1	U1	1	ISL8104IBZ	IC, Linear	IC, Single PWM Controller	14 Ld SOIC	Intersil
2	Q1	1	BSC080N30LS G	MOSFET	30V N-Channel MOSFET	TDSON-08	Infineon
3	Q2, Q4	2	BSC030N03LS G	MOSFET	30V N-Channel MOSFET	TDSON-08	Infineon
4	Q3	DNP		MOSFET			
5	D1	1	BAT54C	Schottky Diode	30V, 200mA Schottky Diode	SOT23	Onsemi
6	L1	1	IHLP5050FD-R68	Inductor	0.68μH, High Current Inductor	SMD	Vishay
7	SW1	1	GT11MSCKE	Toggle Switch	Switchtoggle, SMD, Ultramini,1P, SPST Mini		C&K
<b>CAPACITORS</b>							
8	C1	1		Capacitor, Ceramic, X7R	2200pF, 50V, 10%, ROHS	SM_0603	Generic
9	C2,C7	2		Capacitor, Ceramic, COG	82pF, 50V, 10%, ROHS	SM_0603	Generic
10	C3	1		Capacitor, Ceramic, X7R	1500pF, 50V, 10%, ROHS	SM_0603	Generic
11	C4, C12, C29,C30	4		Capacitor, Ceramic, X5R	1μF, 25V, 10%, ROHS	SM_0603	Generic
12	C6, C10, C25, C26, C27, C28	6		Capacitor, Ceramic, X7R	0.1μF, 50V, 10%, ROHS	SM_0603	Generic
13	C8, C11	2		Capacitor, Ceramic, X7R	1000pF, 50V, 10%, ROHS	SM_0603	Generic
14	C13	1		Capacitor, Ceramic, X7R	0.01μF, 50V, 10%, ROHS	SM_0603	Generic
15	C18, C19, C20	3	35ME330AX	Aluminum Capacitor	330μF, 35V	RAD 10x20	Sanyo
16	C21, C22, C23, C24	4	FP-4R0RE561M-L8R	Polymer Alumium Capacitor	560μF, 4V, 20%, ROHS	RAD 8x8	Fujitsu
17	C5, C9, C14, C15, C16, C17	DNP					
<b>RESISTORS</b>							
18	R1	1		Resistor, Film	23.2kΩ, 1%, 1/16W	SM_0603	Generic
19	R2	1		Resistor, Film	44.2kΩ, 1%, 1/16W	SM_0603	Generic
20	R3	1		Resistor, Film	665Ω, 1%, 1/16W	SM_0603	Generic
21	R4	1		Resistor, Film	11.5kΩ, 1%, 1/16W	SM_0603	Generic
22	R5	1		Resistor, Film	63.4kΩ, 1%, 1/16W	SM_0603	Generic
23	R6	1		Resistor, Film	10kΩ, 1%, 1/16W	SM_0603	Generic
24	R8	1		Resistor, Film	20kΩ, 1%, 1/16W	SM_0603	Generic
25	R9, R11	2		Resistor, Film	4.7Ω, 1%, 1/16W	SM_0603	Generic
26	R12, R13, R14, R19, R20			Resistor, Film	0Ω, 1/16W	SM_0603	Generic
27	R15	1		Resistor, Film	1.15kΩ, 1%, 1/16W	SM_0603	Generic
28	R16	1		Resistor, Film	10Ω, 1%, 1/16W	SM_0603	Generic
29	R18	1		Resistor, Film	2.2Ω, 1%, 1/16W	SM_0603	Generic
30	R7, R10, R17, R21, R22	DNP				SM_0603	
<b>OTHERS</b>							
31	J1, J3	2	111-0702-001	Blinding Post	Conn-Gen, Bind. Post, Red, Thmbnut-Gnd		Johnson Components
32	J2, J4	2	111-0703-001	Blinding Post	Conn-Gen, Bind. Post, Black, Thmbnut-Gnd		Johnson Components

## Application Note 1416

### **ISL8104EVAL1Z Bill of Materials** (Continued)

ID	REFERENCE	QTY	PART NUMBER	PART TYPE	DESCRIPTION	PACKAGE	VENDOR
33	J6, J7	2	1514-2	Turrett Post	Conn-Turret, Terminal Post, TH, ROHS		Keystone
34	J5	1	68000-236-1X3		3-pin Jumper		Berg/FCI
35	TP1 through TP7	7	5002	Test Point	Conn-Mini Test Point, Vertical, White, ROHS		Keystone
36	TP8	DNP					



## ISL8104EVAL1Z Printed Circuit Board Layers

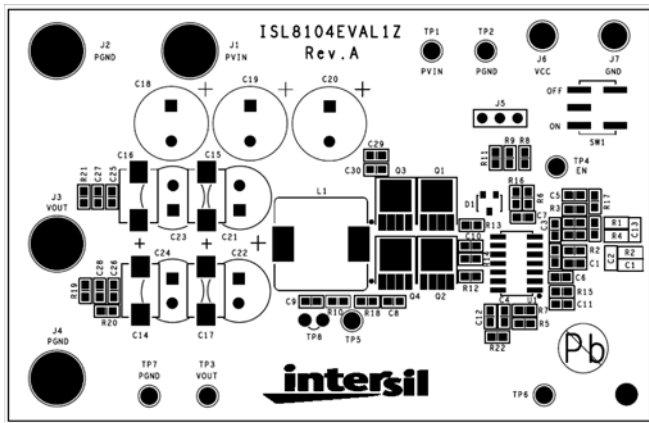


FIGURE 11. ISL8104EVAL1Z - TOP LAYER (SILKSCREEN)

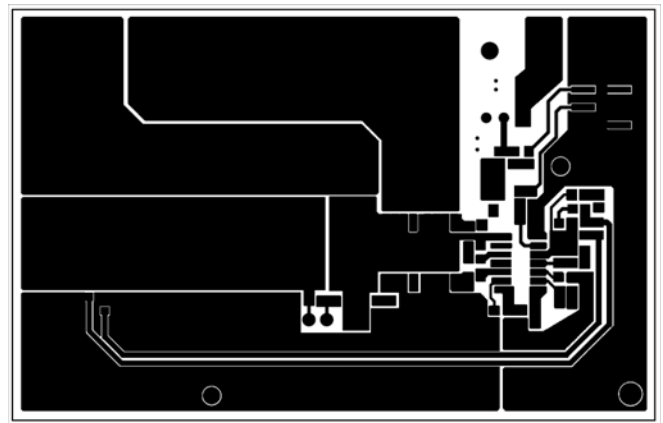


FIGURE 12. ISL8104EVAL1Z - TOP LAYER (COMPONENT SIDE)

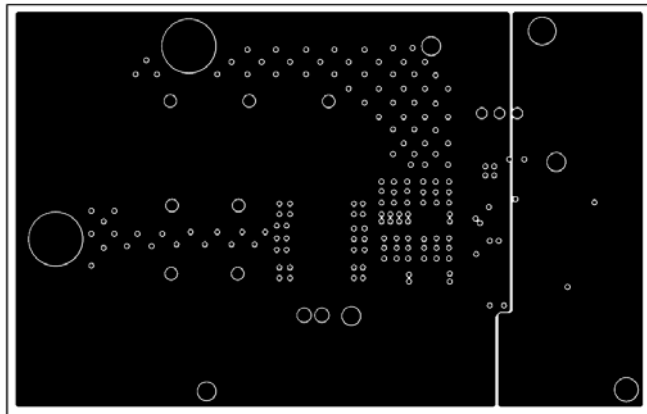


FIGURE 13. ISL8104EVAL1Z - LAYER 2

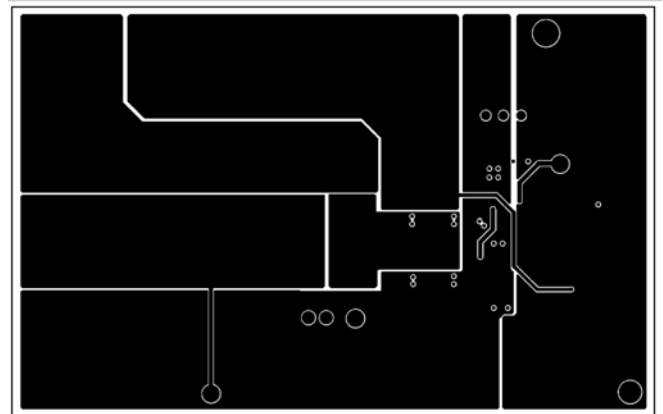


FIGURE 14. ISL8104EVAL1Z - LAYER 3

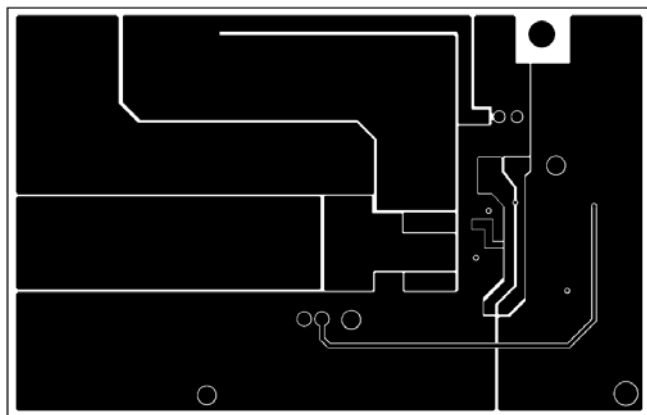


FIGURE 15. ISL8104EVAL1Z - BOTTOM LAYER

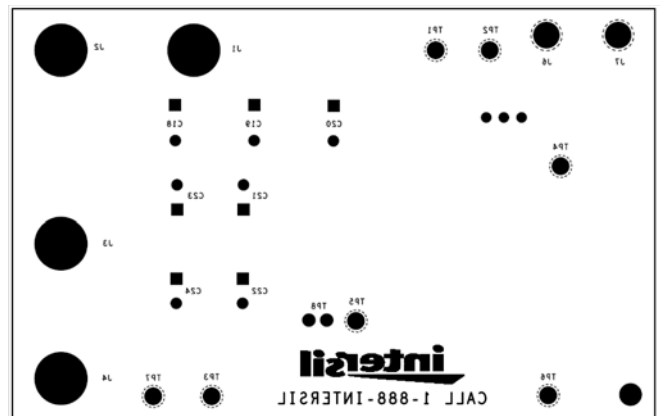
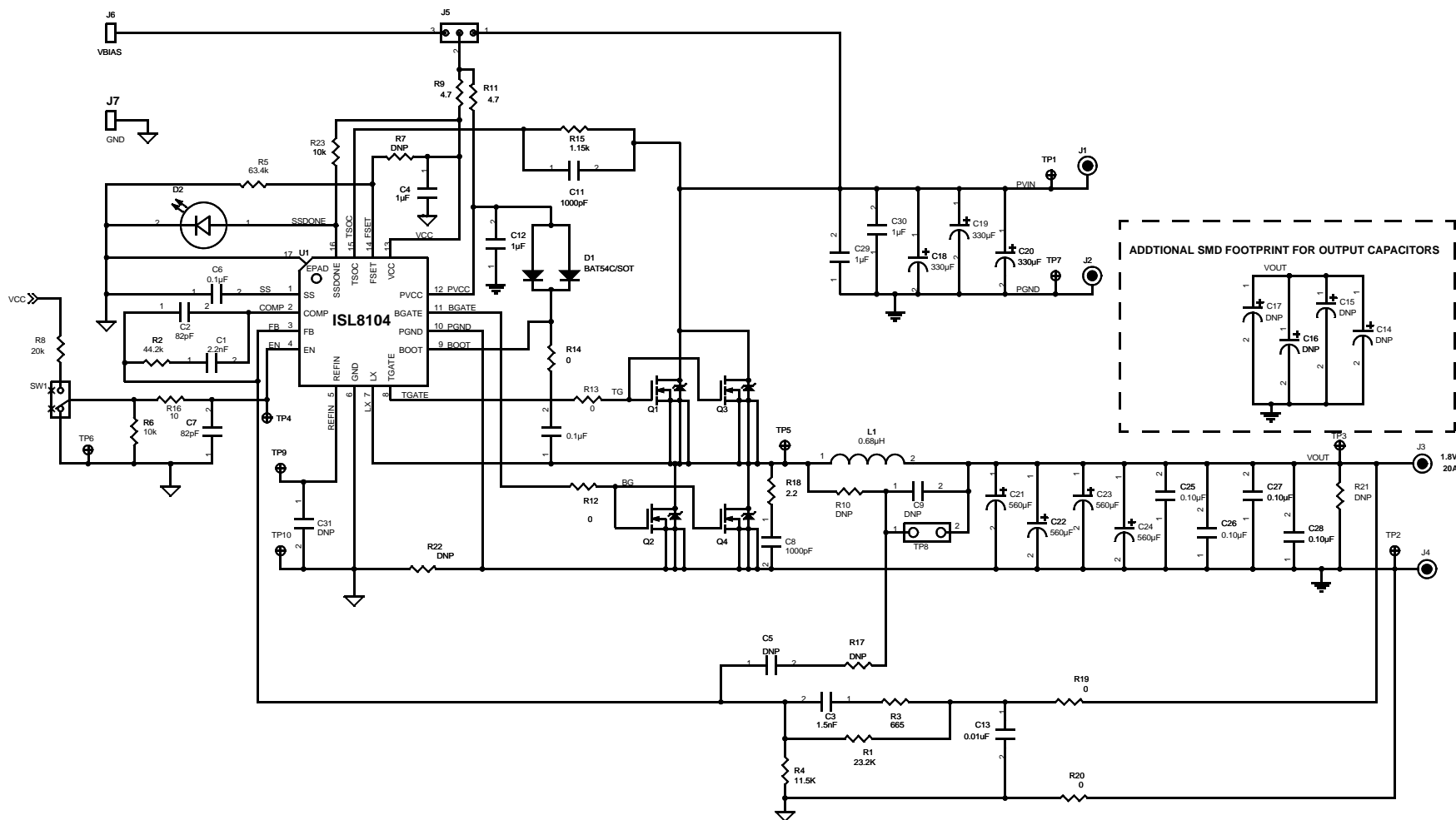


FIGURE 16. ISL8104EVAL1Z - BOTTOM LAYER (SOLDER SIDE)

# ISL8104EVAL2Z Schematic



**ISL8104EVAL2Z Bill of Materials**

ID	REFERENCE	QTY	PART NUMBER	PART TYPE	DESCRIPTION	PACKAGE	VENDOR
1	U1	1	ISL8104IRZ	IC, Linear	IC, Single PWM Controller	16 Ld 4x4 MLFP	Intersil
2	Q1	1	BSC080N30LS G	MOSFET	30V N-Channel MOSFET	TDSON-08	Infineon
3	Q2, Q4	2	BSC030N03LS G	MOSFET	30V N-Channel MOSFET	TDSON-08	Infineon
4	Q3	DNP		MOSFET			
5	D1	1	BAT54C	Schottky Diode	30V, 200mA Schottky diode	SOT23	Onsemi
6	L1	1	IHLP5050FD-R68	Inductor	0.68μH, high current inductor	SMD	Vishay
7	SW1	1	GT11MSCKE	Toggle Switch	Switchtoggle, SMD, Ultramini, 1P, SPST Mini		C&K
8	D2	1	597-3311-407F	LED	Green LED	SMD 1206	Dialight
<b>CAPACITORS</b>							
9	C1	1		Capacitor, Ceramic, X7R	2200pF, 50V, 10%, ROHS	SM_0603	Generic
10	C2, C7	2		Capacitor, Ceramic, COG	82pF, 50V, 10%, ROHS	SM_0603	Generic
11	C3	1		Capacitor, Ceramic, X7R	1500pF, 50V, 10%, ROHS	SM_0603	Generic
12	C4, C12, C29, C30	4		Capacitor, Ceramic, X5R	1μF, 25V, 10%, ROHS	SM_0603	Generic
13	C6, C10, C25, C26, C27, C28	6		Capacitor, Ceramic, X7R	0.1μF, 50V, 10%, ROHS	SM_0603	Generic
14	C8, C11	2		Capacitor, Ceramic, X7R	1000pF, 50V, 10%, ROHS	SM_0603	Generic
15	C13	1		Capacitor, Ceramic, X7R	0.01μF, 50V, 10%, ROHS	SM_0603	Generic
16	C18, C19, C20	3	35ME330AX	Aluminum Capacitor	330μF, 35V	RAD 10x20	Sanyo
17	C21, C22, C23, C24	4	FP-4R0RE561M-L8R	Polymer Alumium Capacitor	560μF, 4V, 20%, ROHS	RAD 8x8	Fujistu
18	C5, C9, C14, C15, C16, C17, C31	DNP					
<b>RESISTORS</b>							
19	R1	1		Resistor, Film	23.2kΩ, 1%, 1/16W	SM_0603	Generic
20	R2	1		Resistor, Film	44.2kΩ, 1%, 1/16W	SM_0603	Generic
21	R3	1		Resistor, Film	665Ω, 1%, 1/16W	SM_0603	Generic
22	R4	1		Resistor, Film	11.5kΩ, 1%, 1/16W	SM_0603	Generic
23	R5	1		Resistor, Film	63.4kΩ, 1%, 1/16W	SM_0603	Generic
24	R6, R23	2		Resistor, Film	10kΩ, 1%, 1/16W	SM_0603	Generic
25	R8	1		Resistor, Film	20kΩ, 1%, 1/16W	SM_0603	Generic
26	R9, R11	2		Resistor, Film	4.7Ω, 1%, 1/16W	SM_0603	Generic
27	R12, R13, R14, R19, R20			Resistor, Film	0Ω, 1/16W	SM_0603	Generic
28	R15	1		Resistor, Film	1.15kΩ, 1%, 1/16W	SM_0603	Generic
29	R16	1		Resistor, Film	10Ω, 1%, 1/16W	SM_0603	Generic
30	R18	1		Resistor, Film	2.2Ω, 1%, 1/16W	SM_0603	Generic
31	R7, R10, R17, R21, R22	DNP				SM_0603	
<b>OTHERS</b>							
32	J1, J3	2	111-0702-001	Blinding Post	Conn-Gen, Bind. Post, RED, Thmbnut-Gnd		Johnson Components

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### **ISL8104EVAL2Z Bill of Materials** (Continued)

ID	REFERENCE	QTY	PART NUMBER	PART TYPE	DESCRIPTION	PACKAGE	VENDOR
33	J2, J4	2	111-0703-001	Blinding Post	Conn-Gen, Bind. Post, Black, Thmbnut-Gnd		Johnson Components
34	J6, J7	2	1514-2	Turrett Post	Conn-Turret, Terminal Post, TH, ROHS		Keystone
35	J5	1	68000-236-1x3		3-pin Jumper		Berg/FCI
36	TP1 through TP7, TP9, TP10	9	5002	Test Point	Conn-Mini Test Point, Vertical, White, ROHS		Keystone
37	TP8	DNP					

## ISL8104EVAL2Z Printed Circuit Board Layers

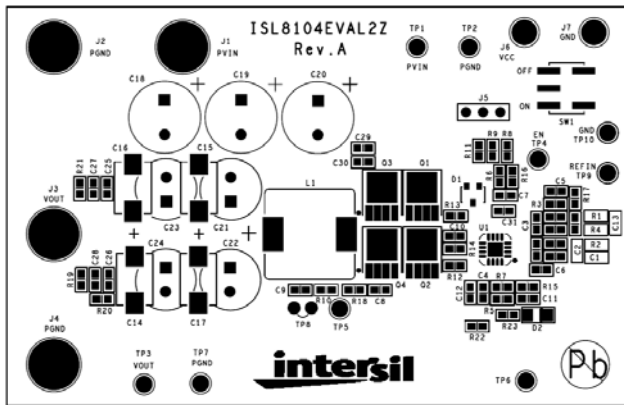


FIGURE 17. ISL8104EVAL2Z - TOP LAYER (SILKSCREEN)

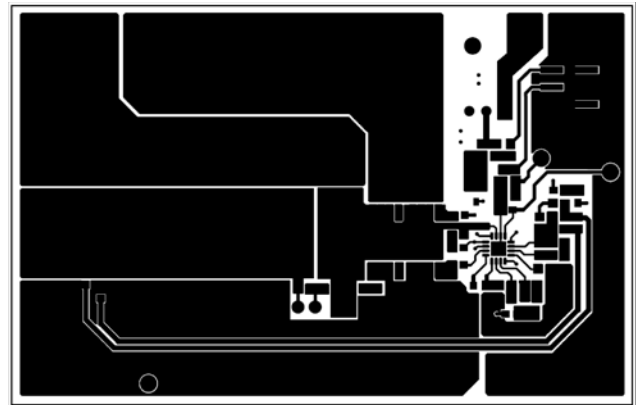


FIGURE 18. ISL8104EVAL2Z - TOP LAYER (COMPONENT SIDE)

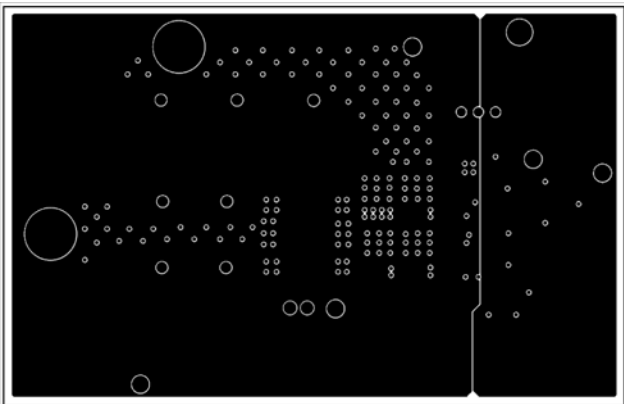


FIGURE 19. ISL8104EVAL2Z - LAYER 2

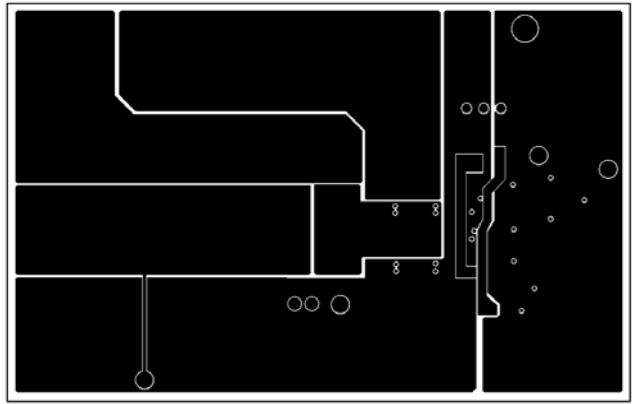


FIGURE 20. ISL8104EVAL2Z - LAYER 3

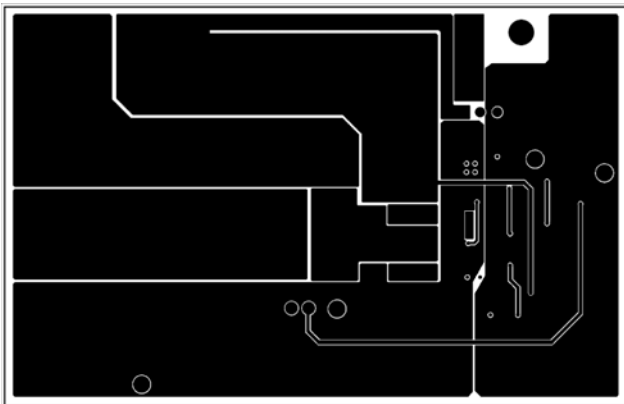


FIGURE 21. ISL8104EVAL2Z - BOTTOM LAYER

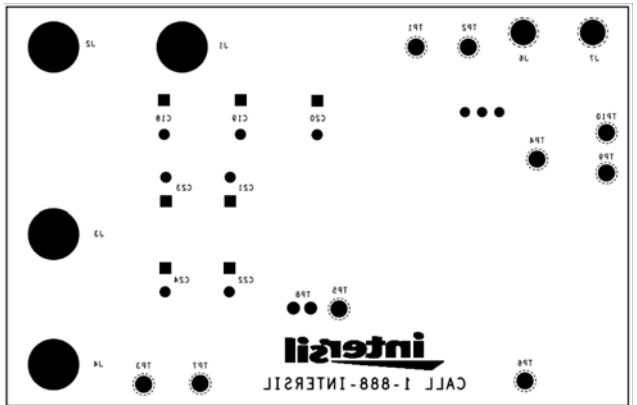


FIGURE 22. ISL8104EVAL1Z - BOTTOM LAYER (SOLDER SIDE)

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